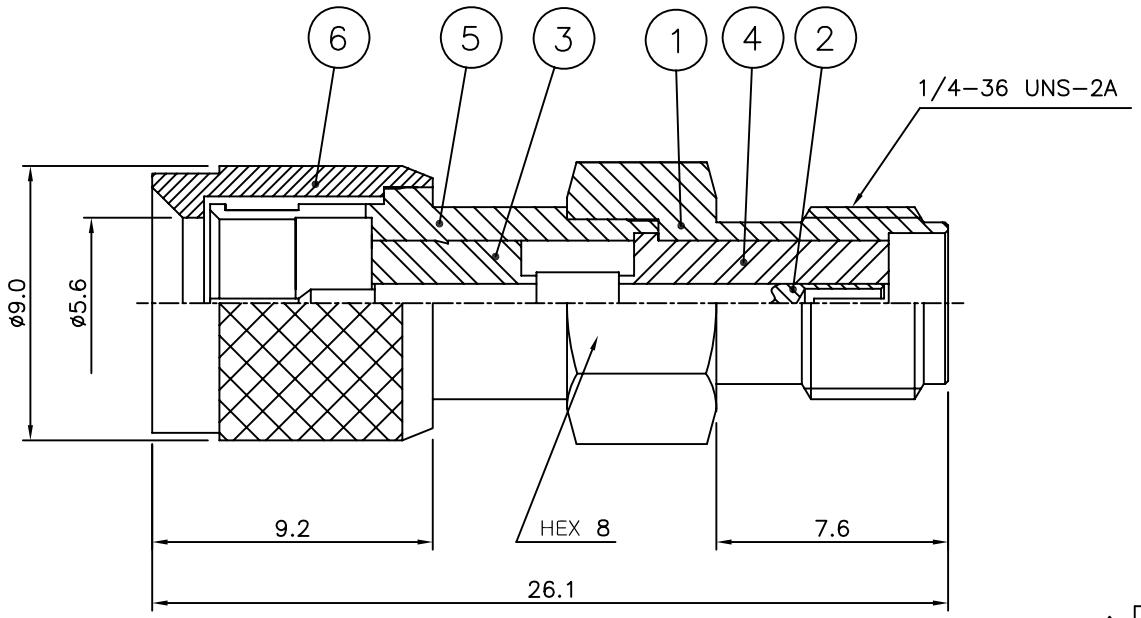
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
I R	Initial Registration	E.H.KIM	I.C.KIM	2012.12.04.
1	[설변No.201810-0003] 원가절감 및 MATING 개선으로 인한 링 삭제	S.Y.EUN	I.C.KIM	2018.10.10.



NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
~~7~~	~~SPRING RING~~	~~1~~	~~BeCu~~	~~Nickel Plate~~	~~DSR00007-5/1~~
6	CAP	1	MBsBD	Nickel Plate	DCU02198-5/1
5	JACK	1	MBsBD	Nickel Plate	DJA00164-5/1
4	INSULATOR	1	TEFLON		DIN02102-N/1
3	INSULATOR	1	TEFLON		DIN02101-N/1
2	CONTACT	1	BeCu	Gold Plate	DAC00238-5/1
1	BODY	1	MBsBD	Nickel Plate	DBD03184-5/1

TOLERANCE	Decimal ±0.2	DATE	2018. 10. 10.
	Angle ±1°	APPROVED BY	I. C. KIM
		CHECKED BY	
MATERIAL	-	DRAWN BY	S. Y. EUN
FINISH	-	SCALE 4/1	UNIT mm

KJ COMTECH
KJ COMTECH CO.,LTD.
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE: SMA(J)-PDM(ø5.55)(P)

A4

DWG NO. AD00469-7/3

REVISION 1

SHEET 1 of 1